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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	3KB (2K x 12)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	72 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	28-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f57-e-p

PIC16F5X

NOTES:

TABLE 2-3: PIC16F59 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0	RA0	TTL	CMOS	Bidirectional I/O pin
RA1	RA1	TTL	CMOS	Bidirectional I/O pin
RA2	RA2	TTL	CMOS	Bidirectional I/O pin
RA3	RA3	TTL	CMOS	Bidirectional I/O pin
RB0	RB0	TTL	CMOS	Bidirectional I/O pin
RB1	RB1	TTL	CMOS	Bidirectional I/O pin
RB2	RB2	TTL	CMOS	Bidirectional I/O pin
RB3	RB3	TTL	CMOS	Bidirectional I/O pin
RB4	RB4	TTL	CMOS	Bidirectional I/O pin
RB5	RB5	TTL	CMOS	Bidirectional I/O pin
RB6/ICSPCLK	RB6	TTL	CMOS	Bidirectional I/O pin
	ICSPCLK	ST	—	Serial programming clock
RB7/ICSPDAT	RB7	TTL	CMOS	Bidirectional I/O pin
	ICSPDAT	ST	CMOS	Serial programming I/O
RC0	RC0	TTL	CMOS	Bidirectional I/O pin
RC1	RC1	TTL	CMOS	Bidirectional I/O pin
RC2	RC2	TTL	CMOS	Bidirectional I/O pin
RC3	RC3	TTL	CMOS	Bidirectional I/O pin
RC4	RC4	TTL	CMOS	Bidirectional I/O pin
RC5	RC5	TTL	CMOS	Bidirectional I/O pin
RC6	RC6	TTL	CMOS	Bidirectional I/O pin
RC7	RC7	TTL	CMOS	Bidirectional I/O pin
RD0	RD0	TTL	CMOS	Bidirectional I/O pin
RD1	RD1	TTL	CMOS	Bidirectional I/O pin
RD2	RD2	TTL	CMOS	Bidirectional I/O pin
RD3	RD3	TTL	CMOS	Bidirectional I/O pin
RD4	RD4	TTL	CMOS	Bidirectional I/O pin
RD5	RD5	TTL	CMOS	Bidirectional I/O pin
RD6	RD6	TTL	CMOS	Bidirectional I/O pin
RD7	RD7	TTL	CMOS	Bidirectional I/O pin
RE4	RE4	TTL	CMOS	Bidirectional I/O pin
RE5	RE5	TTL	CMOS	Bidirectional I/O pin
RE6	RE6	TTL	CMOS	Bidirectional I/O pin
RE7	RE7	TTL	CMOS	Bidirectional I/O pin
T0CKI	T0CKI	ST	—	Clock input to Timer0. Must be tied to Vss or VDD, if not in use, to reduce current consumption.
MCLR/VPP	MCLR	ST	—	Active-low Reset to device. Voltage on the MCLR/VPP pin must not exceed VDD to avoid unintended entering of Programming mode.
	VPP	HV	—	Programming voltage input
OSC1/CLKIN	OSC1	XTAL	—	Oscillator crystal input
	CLKIN	ST	—	External clock source input
OSC2/CLKOUT	OSC2	—	XTAL	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode.
	CLKOUT	—	CMOS	In RC mode, OSC2 pin outputs CLKOUT, which has 1/4 the frequency of OSC1.
VDD	VDD	Power	—	Positive supply for logic and I/O pins
VSS	VSS	Power	—	Ground reference for logic and I/O pins

Legend: I = input I/O = input/output CMOS = CMOS output
O = output — = Not Used XTAL = Crystal input/output
ST = Schmitt Trigger input TTL = TTL input HV = High Voltage

3.0 MEMORY ORGANIZATION

PIC16F5X memory is organized into program memory and data memory. For the PIC16F57 and PIC16F59, which have more than 512 words of program memory, a paging scheme is used. Program memory pages are accessed using one or two STATUS register bits. For the PIC16F57 and PIC16F59, which have a data memory register file of more than 32 registers, a banking scheme is used. Data memory banks are accessed using the File Selection Register (FSR).

3.1 Program Memory Organization

The PIC16F54 has a 9-bit Program Counter (PC) capable of addressing a 512 x 12 program memory space (Figure 3-1). The PIC16F57 and PIC16F59 have an 11-bit Program Counter capable of addressing a 2K x 12 program memory space (Figure 3-2). Accessing a location above the physically implemented address will cause a wraparound.

A NOP at the Reset vector location will cause a restart at location 000h. The Reset vector for the PIC16F54 is at 1FFh. The Reset vector for the PIC16F57 and PIC16F59 is at 7FFh. See **Section 3.5 “Program Counter”** for additional information using CALL and GOTO instructions.

FIGURE 3-2: PIC16F57/PIC16F59 PROGRAM MEMORY MAP AND STACK

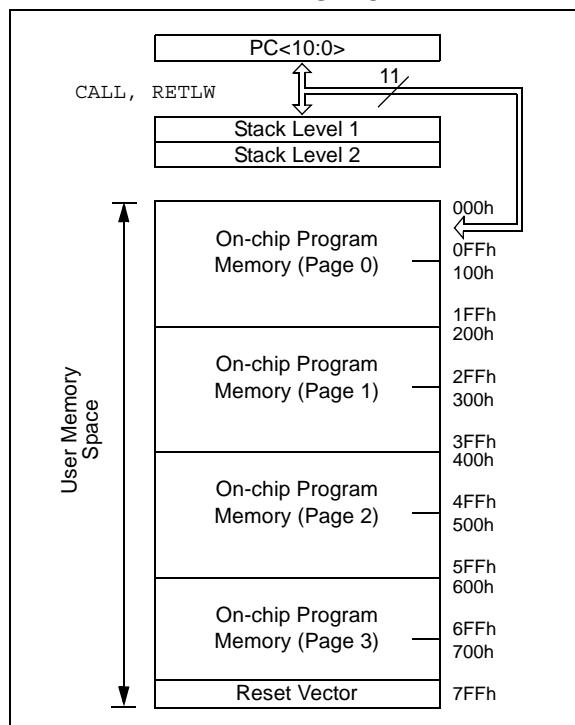
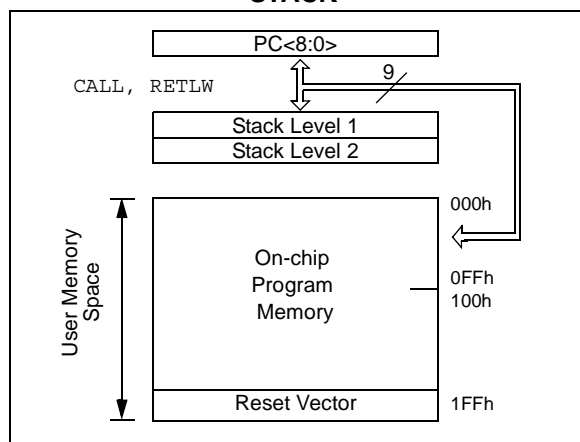


FIGURE 3-1: PIC16F54 PROGRAM MEMORY MAP AND STACK



PIC16F5X

3.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFR) are registers used by the CPU and peripheral functions to control the operation of the device (Table 3-1).

The Special Function Registers can be classified into two sets. The Special Function Registers associated with the “core” functions are described in this section. Those related to the operation of the peripheral features are described in the section for each peripheral feature.

TABLE 3-1: SPECIAL FUNCTION REGISTER SUMMARY

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Details on Page
N/A	TRIS	I/O Control Registers (TRISA, TRISB, TRISC, TRISD, TRISE)								1111 1111	29
N/A	OPTION	Contains control bits to configure Timer0 and Timer0/WDT prescaler								--11 1111	18
00h	INDF	Uses contents of FSR to address data memory (not a physical register)								xxxx xxxx	20
01h	TMR0	Timer0 Module Register								xxxx xxxx	34
02h	PCL ⁽¹⁾	Low order 8 bits of PC								1111 1111	19
03h	STATUS	PA2	PA1	PA0	\overline{TO}	\overline{PD}	Z	DC	C	0001 1xxx	17
04h	FSR ⁽³⁾	Indirect data memory Address Pointer								111x xxxx	20
04h	FSR ⁽⁴⁾	Indirect data memory Address Pointer								1xxx xxxx	20
04h	FSR ⁽⁵⁾	Indirect data memory Address Pointer								xxxx xxxx	20
05h	PORTA ⁽⁶⁾	—	—	—	—	RA3	RA2	RA1	RA0	---- xxxx	29
06h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx	29
07h	PORTC ⁽²⁾	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx	29
08h	PORTD ⁽⁷⁾	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx	29
09h	PORTE ^{(6), (7)}	RE7	RE6	RE5	RE4	—	—	—	—	xxxx ----	29

Legend: Shaded cells = unimplemented or unused, — = unimplemented, read as ‘0’ (if applicable), x = unknown, u = unchanged

Note 1: The upper byte of the Program Counter is not directly accessible. See **Section 3.5 “Program Counter”** for an explanation of how to access these bits.

2: File address 07h is a General Purpose Register on the PIC16F54.

3: PIC16F54 only.

4: PIC16F57 only.

5: PIC16F59 only.

6: Unimplemented bits are read as ‘0’s.

7: File address 08h and 09h are General Purpose Registers on the PIC16F54 and PIC16F57.

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3.6 Stack

The PIC16F54 device has a 9-bit wide, two-level hardware PUSH/POP stack. The PIC16F57 and PIC16F59 devices have an 11-bit wide, two-level hardware PUSH/POP stack.

A `CALL` instruction will PUSH the current value of stack 1 into stack 2 and then PUSH the current program counter value, incremented by one, into stack level 1. If more than two sequential `CALL`'s are executed, only the most recent two return addresses are stored.

A `RETLW` instruction will POP the contents of stack level 1 into the program counter and then copy stack level 2 contents into level 1. If more than two sequential `RETLW`'s are executed, the stack will be filled with the address previously stored in level 2.

Note: The W register will be loaded with the literal value specified in the instruction. This is particularly useful for the implementation of data look-up tables within the program memory.

For the `RETLW` instruction, the PC is loaded with the Top-of-Stack (TOS) contents. All of the devices covered in this data sheet have a two-level stack. The stack has the same bit width as the device PC, therefore, paging is not an issue when returning from a sub-routine.

3.7 Indirect Data Addressing; INDF and FSR Registers

The INDF register is not a physical register. Addressing INDF actually addresses the register whose address is contained in the FSR Register (FSR is a *pointer*). This is indirect addressing.

EXAMPLE 3-1: INDIRECT ADDRESSING

- Register file 08 contains the value 10h
- Register file 09 contains the value 0Ah
- Load the value 08 into the FSR register
- A read of the INDF register will return the value of 10h
- Increment the value of the FSR register by one (FSR = 09h)
- A read of the INDF register now will return the value of 0Ah.

Reading INDF itself indirectly (FSR = 0) will produce 00h. Writing to the INDF register indirectly results in a no-operation (although Status bits may be affected).

A simple program to clear RAM locations 10h-1Fh using indirect addressing is shown in Example 3-2.

EXAMPLE 3-2: HOW TO CLEAR RAM USING INDIRECT ADDRESSING

```
MOVLW H'10' ;initialize pointer
MOVWF FSR   ;to RAM
NEXT      CLRWF INDF ;clear INDF Register
          INCF FSR,F ;inc pointer
          BTFSC FSR,4 ;all done?
          GOTO NEXT ;NO, clear next
CONTINUE
          :          ;YES, continue
```

The FSR is either a 5-bit (PIC16F54), 7-bit (PIC16F57) or 8-bit (PIC16F59) wide register. It is used in conjunction with the INDF register to indirectly address the data memory area.

The FSR<4:0> bits are used to select data memory addresses 00h to 1Fh.

PIC16F54: This does not use banking. FSR<7:5> bits are unimplemented and read as '1's.

PIC16F57: FSR<7> bit is unimplemented and read as '1'. FSR<6:5> are the bank select bits and are used to select the bank to be addressed (00 = Bank 0, 01 = Bank 1, 10 = Bank 2, 11 = Bank 3).

PIC16F59: FSR<7:5> are the bank select bits and are used to select the bank to be addressed (000 = Bank 0, 001 = Bank 1, 010 = Bank 2, 011 = Bank 3, 100 = Bank 4, 101 = Bank 5, 110 = Bank 6, 111 = Bank 7).

Note: A `CLRF FSR` instruction may not result in an FSR value of 00h if there are unimplemented bits present in the FSR.

PIC16F5X

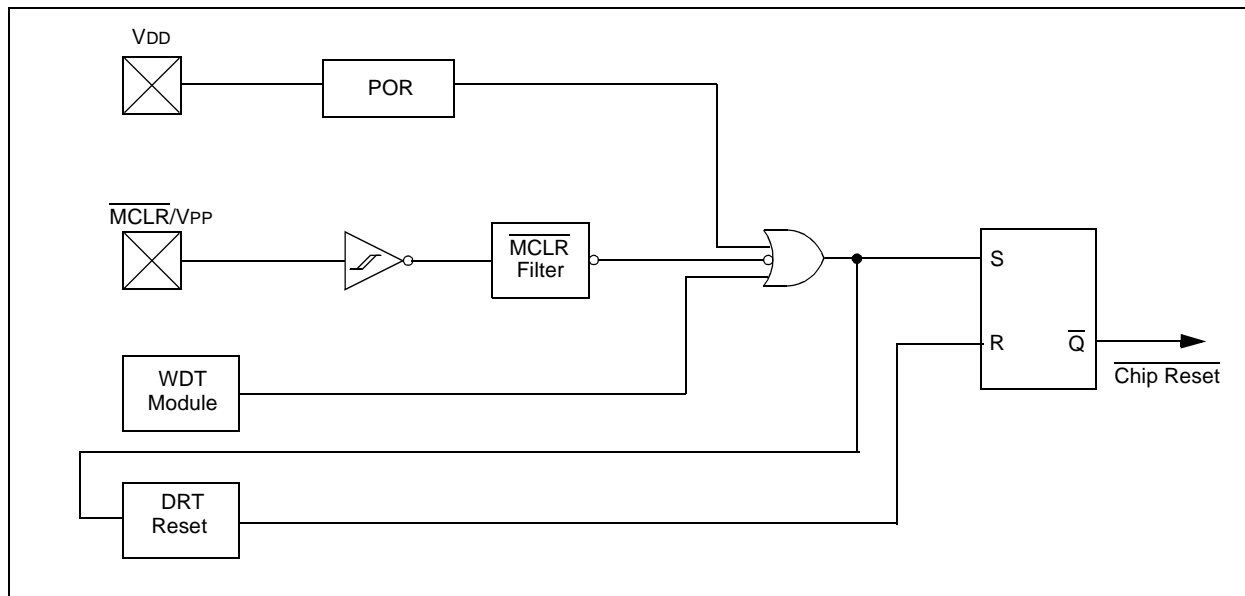
TABLE 5-3: RESET CONDITIONS FOR ALL REGISTERS

Register	Address	Power-on Reset	MCLR or WDT Reset
W	N/A	xxxx xxxx	uuuu uuuu
TRIS	N/A	1111 1111	1111 1111
OPTION	N/A	--11 1111	--11 1111
INDF	00h	xxxx xxxx	uuuu uuuu
TMR0	01h	xxxx xxxx	uuuu uuuu
PCL	02h	1111 1111	1111 1111
STATUS	03h	0001 1xxx	000q quuu
FSR ⁽¹⁾	04h	111x xxxx	111u uuuu
FSR ⁽²⁾	04h	1xxx xxxx	1uuu uuuu
FSR ⁽³⁾	04h	xxxx xxxx	uuuu uuuu
PORTA	05h	---- xxxx	---- uuuu
PORTB	06h	xxxx xxxx	uuuu uuuu
PORTC ⁽⁴⁾	07h	xxxx xxxx	uuuu uuuu
PORTD ⁽⁵⁾	08h	xxxx xxxx	uuuu uuuu
PORTE ⁽⁵⁾	09h	xxxx ----	uuuu ----

Legend: u = unchanged, x = unknown, – = unimplemented, read as '0', q = see tables in Table 5-1 for possible values.

- Note 1:** PIC16F54 only.
Note 2: PIC16F57 only.
Note 3: PIC16F59 only.
Note 4: General purpose register file on PIC16F54.
Note 5: General purpose register file on PIC16F54 and PIC16F57.

FIGURE 5-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



5.2 Device Reset Timer (DRT)

The Device Reset Timer (DRT) provides an 18 ms nominal time-out on Reset regardless of the oscillator mode used. The DRT operates on an internal RC oscillator. The processor is kept in Reset as long as the DRT is active. The DRT delay allows VDD to rise above VDD min. and for the chosen oscillator to stabilize.

Oscillator circuits, based on crystals or ceramic resonators, require a certain time after power-up to establish a stable oscillation. The on-chip DRT keeps the device in a Reset condition for approximately 18 ms after the voltage on the MCLR/VPP pin has reached a logic high (VIH) level. Thus, external RC networks connected to the MCLR input are not required in most cases, allowing for savings in cost-sensitive and/or space restricted applications.

The device Reset time delay will vary from chip-to-chip due to VDD, temperature and process variation. See AC parameters for details.

The DRT will also be triggered upon a Watchdog Timer time-out. This is particularly important for applications using the WDT to wake the PIC16F5X from Sleep mode automatically.

5.3 Reset on Brown-Out

A Brown-out is a condition where device power (VDD) dips below its minimum value, but not to zero, and then recovers. The device should be reset in the event of a Brown-out.

To reset PIC16F5X devices when a Brown-out occurs, external Brown-out protection circuits may be built, as shown in Figure 5-6, Figure 5-7 and Figure 5-8.

FIGURE 5-6: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1

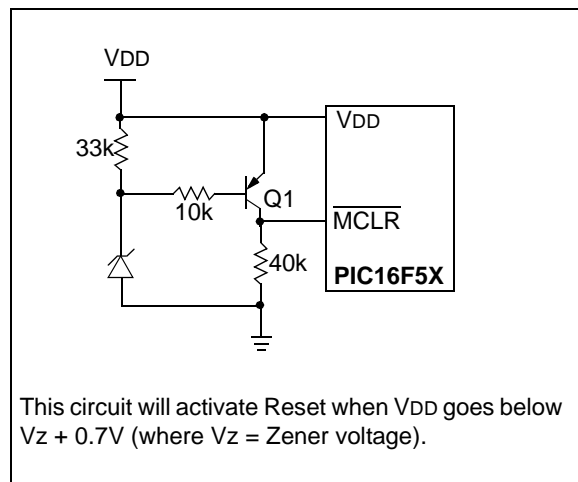


FIGURE 5-7: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2

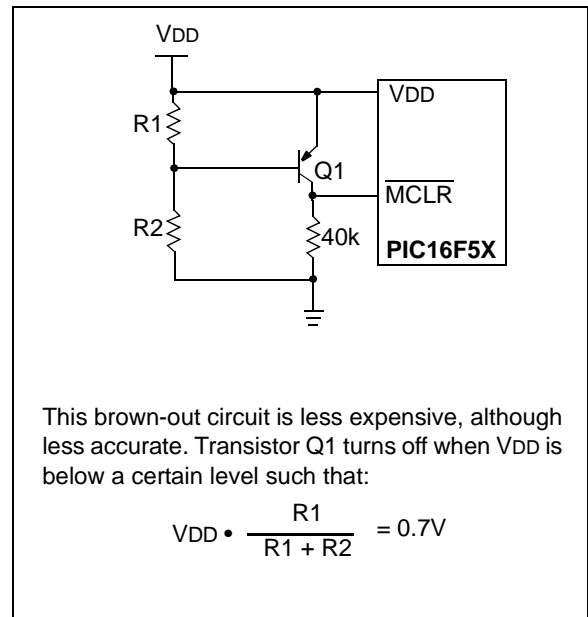
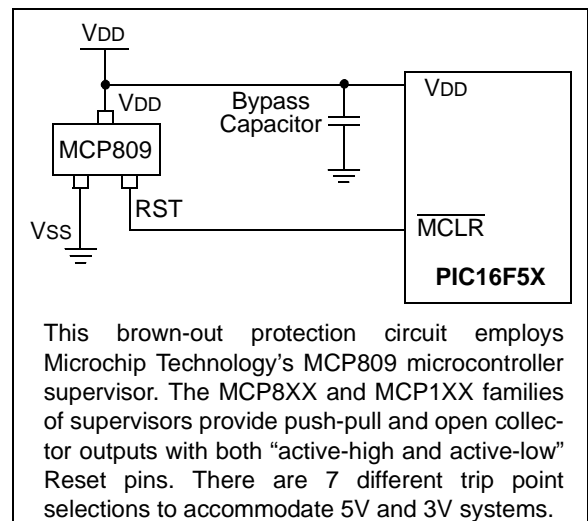


FIGURE 5-8: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 3



7.0 TIMER0 MODULE AND TMR0 REGISTER

The Timer0 module has the following features:

- 8-bit Timer/Counter register, TMR0
 - Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
 - Edge select for external clock

Figure 7-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing the T0CS bit (OPTION<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two cycles (Figure 7-2 and Figure 7-3). The user can work around this by writing an adjusted value to the TMR0 register.

Counter mode is selected by setting the T0CS bit (OPTION<5>). In this mode, Timer0 will increment either on every rising or falling edge of pin T0CKI. The incrementing edge is determined by the source edge select bit T0SE (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in **Section 7.1 “Using Timer0 with an External Clock”**.

Note: The prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both.

The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4,..., 1:256 are selectable. **Section 7.2 “Prescaler”** details the operation of the prescaler.

A summary of registers associated with the Timer0 module is found in Table 7-1.

FIGURE 7-1: TIMER0 BLOCK DIAGRAM

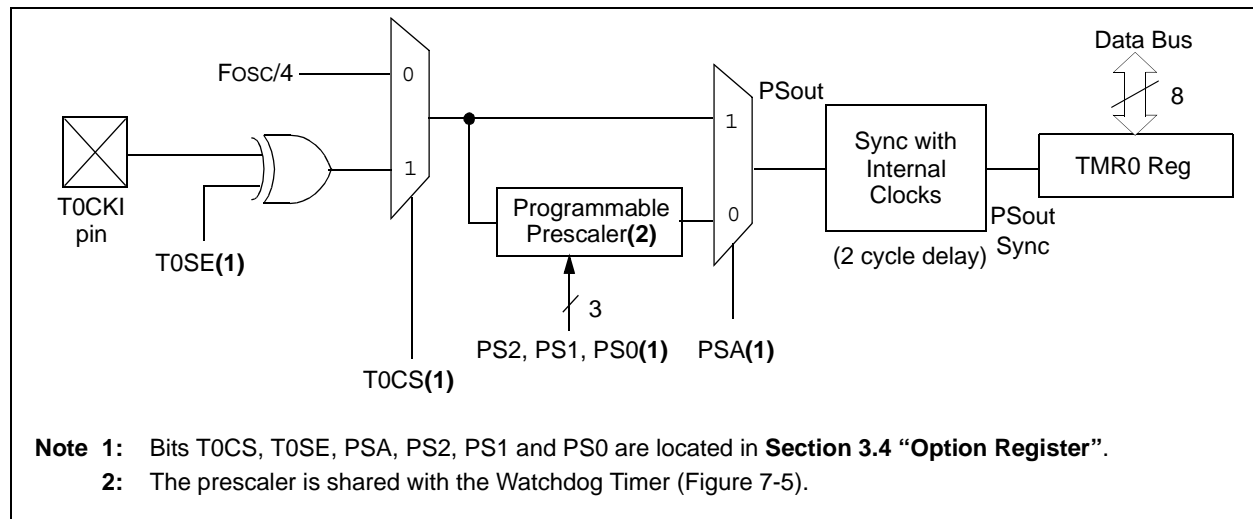
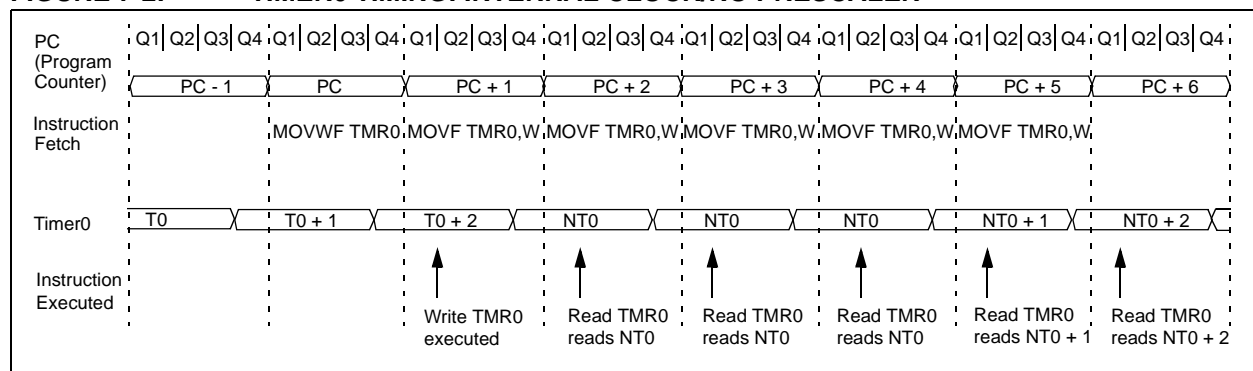


FIGURE 7-2: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALER



8.3 Power-Down Mode (Sleep)

A device may be powered down (Sleep) and later powered up (wake-up from Sleep).

8.3.1 SLEEP

The Power-down mode is entered by executing a `SLEEP` instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the \overline{TO} bit (`STATUS<4>`) is set, the \overline{PD} bit (`STATUS<3>`) is cleared and the oscillator driver is turned off. The I/O ports maintain the status they had before the `SLEEP` instruction was executed (driving high, driving low or high-impedance).

It should be noted that a Reset generated by a WDT time-out does not drive the \overline{MCLR}/V_{PP} pin low.

For lowest current consumption while powered down, the T_{OCLK} input should be at V_{DD} or V_{SS} and the \overline{MCLR}/V_{PP} pin must be at a logic high level ($\overline{MCLR} = V_{IH}$).

8.3.2 WAKE-UP FROM SLEEP

The device can wake-up from Sleep through one of the following events:

1. An external Reset input on \overline{MCLR}/V_{PP} pin.
2. A Watchdog Timer time-out Reset (if WDT was enabled).

Both of these events cause a device Reset. The \overline{TO} and \overline{PD} bits can be used to determine the cause of device Reset. The \overline{TO} bit is cleared if a WDT time-out occurred (and caused wake-up). The \overline{PD} bit, which is set on power-up, is cleared when `SLEEP` is invoked.

The WDT is cleared when the device wakes from Sleep, regardless of the wake-up source.

8.4 Program Verification/Code Protection

If the code protection bit has not been programmed, the on-chip program memory can be read out for verification purposes.

Once code protection is enabled, all program memory locations above 0x3F read all '0's. Program memory locations 0x00-0x3F are always unprotected. The user ID locations and the Configuration Word read out in an unprotected fashion. It is possible to program the user ID locations and the Configuration Word after code protect is enabled.

8.5 User ID Locations

Four memory locations are designated as user ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution, but are readable and writable during Program/Verify.

Use only the lower 4 bits of the user ID locations and always program the upper 8 bits as '1's.

Note: Microchip will assign a unique pattern number for QTP and SQTP requests. This pattern number will be unique and traceable to the submitted code.

8.6 In-Circuit Serial Programming™ (ICSP™)

The PIC16F5X microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground and programming voltage. This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. Thus, the most recent firmware or custom firmware can be programmed.

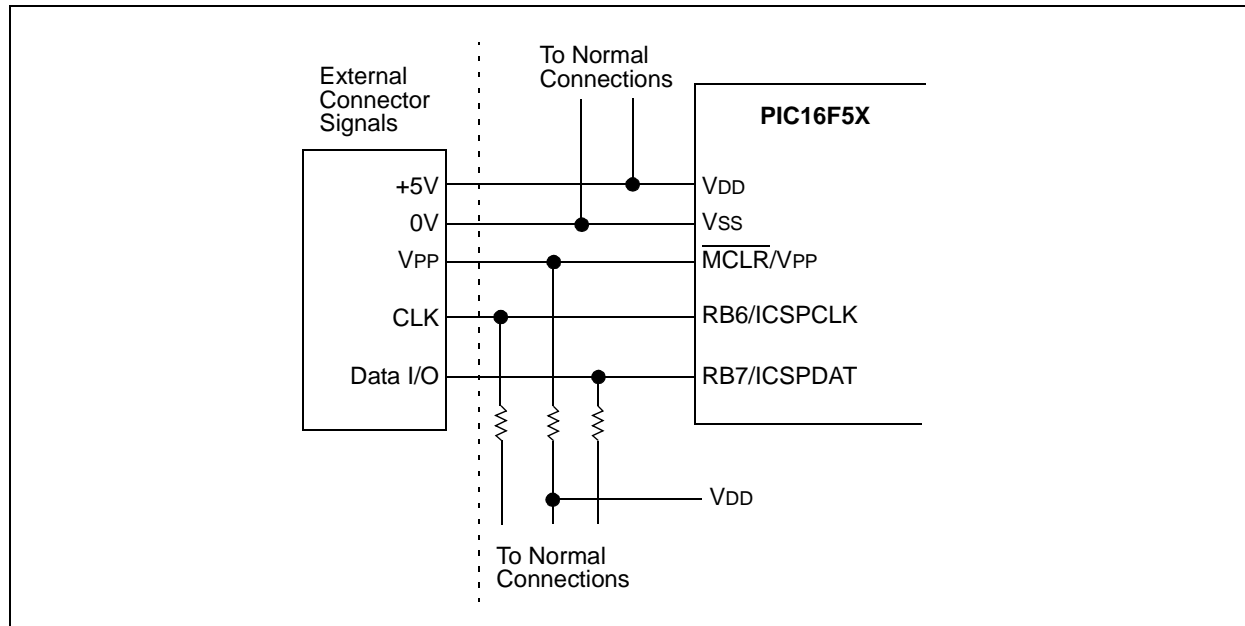
The device is placed into a Program/Verify mode by holding the RB6 and RB7 pins low while raising the \overline{MCLR} (V_{PP}) pin from V_{IL} to V_{IH} (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

A 6-bit command is then supplied to the device. Depending on the command, 14 bits of program data are then supplied to or from the device, depending if the command was a Load or a Read. For complete details of serial programming, please refer to the respective Programming Specifications: "PIC16F54 Memory Programming Specification" (DS41207), "PIC16F57 Memory Programming Specification" (DS41208), and "PIC16F59 Memory Programming Specification" (DS41243).

A typical In-Circuit Serial Programming connection is shown in Figure 8-1.

PIC16F5X

FIGURE 8-1: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING™ CONNECTION



9.0 INSTRUCTION SET SUMMARY

Each PIC16F5X instruction is a 12-bit word divided into an opcode, which specifies the instruction type, and one or more operands which further specify the operation of the instruction. The PIC16F5X instruction set summary in Table 9-2 groups the instructions into byte-oriented, bit-oriented, and literal and control operations. Table 9-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator is used to specify which one of the 32 file registers in that bank is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an 8- or 9-bit constant or literal value.

TABLE 9-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x1F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0 (store result in W) d = 1 (store result in file register 'f') Default is d = 1
label	Label name
TOS	Top-of-Stack
PC	Program Counter
WDT	Watchdog Timer Counter
\overline{TO}	Time-out bit
\overline{PD}	Power-down bit
dest	Destination, either the W register or the specified register file location
[]	Options
()	Contents
→	Assigned to
< >	Register bit field
∈	In the set of
<i>italics</i>	User defined term

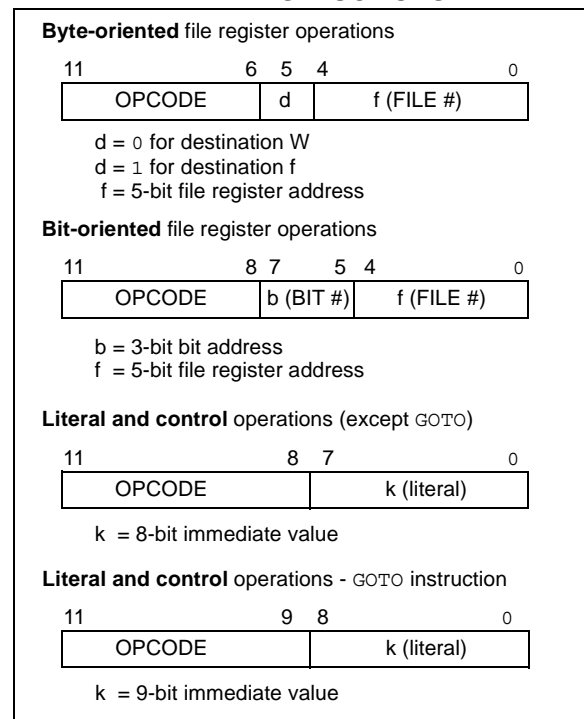
All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time would be 1 μs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time would be 2 μs.

Figure 9-1 shows the three general formats that the instructions can have. All examples in the figure use the following format to represent a hexadecimal number:

0xhhh

where 'h' signifies a hexadecimal digit.

FIGURE 9-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16F5X

RLF Rotate Left f through Carry

Syntax: [*label*] RLF f, d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

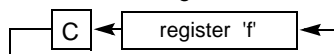
Operation: See description below

Status Affected: C

Encoding:

0011	01df	ffff
------	------	------

Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag (STATUS<0>). If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is stored back in register 'f'.



Words: 1

Cycles: 1

Example: RLF REG1, 0

Before Instruction

REG1 = 1110 0110

C = 0

After Instruction

REG1 = 1110 0110

W = 1100 1100

C = 1

RRF Rotate Right f through Carry

Syntax: [*label*] RRF f, d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

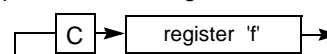
Operation: See description below

Status Affected: C

Encoding:

0011	00df	ffff
------	------	------

Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag (STATUS<0>). If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'.



Words: 1

Cycles: 1

Example: RRF REG1, 0

Before Instruction

REG1 = 1110 0110

C = 0

After Instruction

REG1 = 1110 0110

W = 0111 0011

C = 0

Sleep Go into Standby Mode

Syntax: [*label*] Sleep

Operands: None

Operation: 00h → WDT;
 0 → WDT prescaler; if assigned
 1 → \overline{TO} ;
 0 → \overline{PD}

Status Affected: \overline{TO} , \overline{PD}

Encoding:

0000	0000	0011
------	------	------

Description: Time-out Status bit (\overline{TO}) is set. The power-down Status bit (\overline{PD}) is cleared. The WDT and its prescaler are cleared. The processor is put into Sleep mode with the oscillator stopped. See section on Sleep for more details.

Words: 1

Cycles: 1

Example: SLEEP

SUBWF Subtract W from f

Syntax: `[label] SUBWF f, d`

Operands: $0 \leq f \leq 31$
 $d \in [0, 1]$

Operation: $(f) - (W) \rightarrow (\text{dest})$

Status Affected: C, DC, Z

Encoding:

0000	10df	ffff
------	------	------

Description: Subtract (2's complement method) the W register from register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example 1: `SUBWF REG1, 1`

Before Instruction

REG1 = 3

W = 2

C = ?

After Instruction

REG1 = 1

W = 2

C = 1 ; result is positive

Example 2:

Before Instruction

REG1 = 2

W = 2

C = ?

After Instruction

REG1 = 0

W = 2

C = 1 ; result is zero

Example 3:

Before Instruction

REG1 = 1

W = 2

C = ?

After Instruction

REG1 = 0xFF

W = 2

C = 0 ; result is negative

SWAPF Swap Nibbles in f

Syntax: `[label] SWAPF f, d`

Operands: $0 \leq f \leq 31$
 $d \in [0, 1]$

Operation: $(f<3:0>) \rightarrow (\text{dest}<7:4>);$
 $(f<7:4>) \rightarrow (\text{dest}<3:0>)$

Status Affected: None

Encoding:

0011	10df	ffff
------	------	------

Description: The upper and lower nibbles of register 'f' are exchanged. If 'd' is '0', the result is placed in W register. If 'd' is '1', the result is placed in register 'f'.

Words: 1

Cycles: 1

Example: `SWAPF REG1, 0`

Before Instruction

REG1 = 0xA5

After Instruction

REG1 = 0xA5

W = 0x5A

TRIS Load TRIS Register

Syntax: `[label] TRIS f`

Operands: $f = 5, 6, 7, 8 \text{ or } 9$

Operation: $(W) \rightarrow \text{TRIS register } f$

Status Affected: None

Encoding:

0000	0000	0fff
------	------	------

Description: TRIS register 'f' ($f = 5, 6 \text{ or } 7$) is loaded with the contents of the W register.

Words: 1

Cycles: 1

Example: `TRIS PORTB`

Before Instruction

W = 0xA5

After Instruction

TRISB = 0xA5

10.11 PICSTART Plus Development Programmer

The PICSTART Plus Development Programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus Development Programmer supports most PIC devices in DIP packages up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus Development Programmer is CE compliant.

10.12 PICkit 2 Development Programmer

The PICkit™ 2 Development Programmer is a low-cost programmer and selected Flash device debugger with an easy-to-use interface for programming many of Microchip's baseline, mid-range and PIC18F families of Flash memory microcontrollers. The PICkit 2 Starter Kit includes a prototyping development board, twelve sequential lessons, software and HI-TECH's PICC™ Lite C compiler, and is designed to help get up to speed quickly using PIC® microcontrollers. The kit provides everything needed to program, evaluate and develop applications using Microchip's powerful, mid-range Flash memory family of microcontrollers.

10.13 Demonstration, Development and Evaluation Boards

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart® battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Check the Microchip web page (www.microchip.com) and the latest *"Product Selector Guide"* (DS00148) for the complete list of demonstration, development and evaluation kits.

PIC16F5X

11.3 DC Characteristics PIC16F5X

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended				
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
D030	VIL	Input Low Voltage					
		I/O Ports	VSS	—	0.8V	V	4.5V < VDD ≤ 5.5V
		I/O Ports	VSS	—	0.15 VDD	V	VDD ≤ 4.5V
		MCLR (Schmitt Trigger)	VSS	—	0.15 VDD	V	
		T0CKI (Schmitt Trigger)	VSS	—	0.15 VDD	V	
		OSC1 (Schmitt Trigger)	VSS	—	0.15 VDD	V	RC mode ⁽³⁾
		OSC1	VSS	—	0.3 VDD	V	HS mode
			VSS	—	0.3	V	XT mode
D040	VIH	Input High Voltage					
		I/O ports	2.0	—	VDD	V	4.5V < VDD ≤ 5.5V
		I/O ports	0.25 VDD + 0.8	—	VDD	V	VDD ≤ 4.5V
		MCLR (Schmitt Trigger)	0.85 VDD	—	VDD	V	
		T0CKI (Schmitt Trigger)	0.85 VDD	—	VDD	V	
		OSC1 (Schmitt Trigger)	0.85 VDD	—	VDD	V	RC mode ⁽³⁾
		OSC1	0.7 VDD	—	VDD	V	HS mode
			1.6	—	VDD	V	XT mode
D060	IIL	Input Leakage Current^(1, 2)					
		I/O ports	—	—	±1.0	μA	VSS ≤ VPIN ≤ VDD, pin at high-impedance
		MCLR	—	—	±5.0	μA	VSS ≤ VPIN ≤ VDD
		T0CKI	—	—	±5.0	μA	VSS ≤ VPIN ≤ VDD
		OSC1	—	—	±5.0	μA	VSS ≤ VPIN ≤ VDD, XT, HS and LP modes
D080 D083	VOL	Output Low Voltage					
		I/O ports	—	—	0.6	V	IOL = 8.5 mA, VDD = 4.5V
		OSC2/CLKOUT (RC mode)	—	—	0.6	V	IOL = 1.6 mA, VDD = 4.5V
D090 D092	VOH	Output High Voltage⁽²⁾					
		I/O ports ⁽²⁾	VDD - 0.7	—	—	V	IOH = -3.0 mA, VDD = 4.5V
		OSC2/CLKOUT (RC mode)	VDD - 0.7	—	—	V	IOH = -1.3 mA, VDD = 4.5V

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: The leakage current on the MCLR/VPP pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltage.

2: Negative current is defined as coming out of the pin.

3: For the RC mode, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F5X be driven with external clock in RC mode.

PIC16F5X

TABLE 11-1: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS		Standard Operating Conditions (unless otherwise specified) Operating Temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended					
Parameter No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
	FOSC	External CLKIN Frequency ⁽¹⁾	DC	—	4.0	MHz	XT Osc mode
			DC	—	20	MHz	HS Osc mode
			DC	—	200	kHz	LP Osc mode
		Oscillator Frequency ⁽¹⁾	DC	—	4.0	MHz	RC Osc mode
			0.1	—	4.0	MHz	XT Osc mode
			4.0	—	20	MHz	HS Osc mode
			5.0	—	200	kHz	LP Osc mode
1	TOSC	External CLKIN Period ⁽¹⁾	250	—	—	ns	XT Osc mode
			50	—	—	ns	HS Osc mode
			5.0	—	—	μs	LP Osc mode
		Oscillator Period ⁽¹⁾	250	—	—	ns	RC Osc mode
			250	—	10,000	ns	XT Osc mode
			50	—	250	ns	HS Osc mode
			5.0	—	—	μs	LP Osc mode
2	TCY	Instruction Cycle Time ⁽²⁾	—	4/FOSC	—	—	
3	TosL, TosH	Clock in (OSC1) Low or High Time	50*	—	—	ns	XT oscillator
			20*	—	—	ns	HS oscillator
			2.0*	—	—	μs	LP oscillator
4	TosR, TosF	Clock in (OSC1) Rise or Fall Time	—	—	25*	ns	XT oscillator
			—	—	5*	ns	HS oscillator
			—	—	50*	ns	LP oscillator

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.
When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (TCY) equals four times the input oscillator time base period.

PIC16F5X

FIGURE 11-5: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING — PIC16F5X

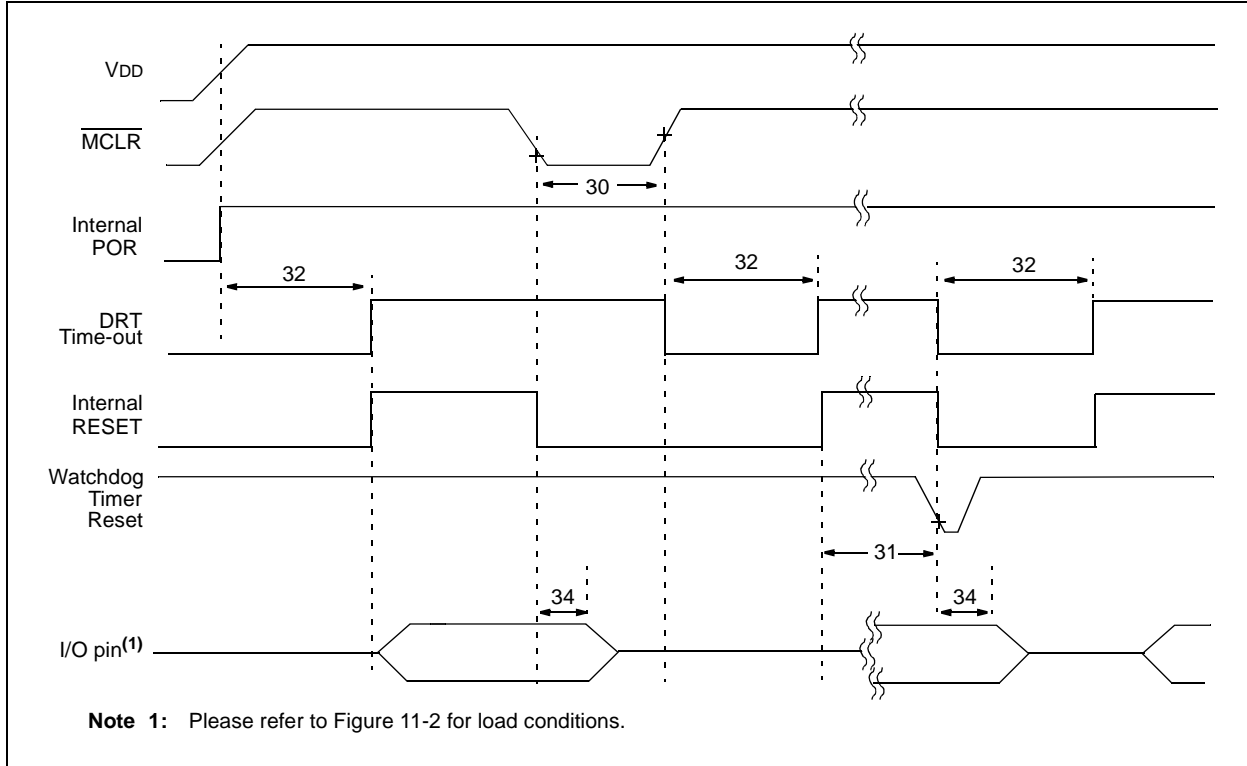


TABLE 11-3: RESET, WATCHDOG TIMER AND DEVICE RESET TIMER – PIC16F5X

AC CHARACTERISTICS			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
30	TMCL	MCLR Pulse Width (low)	2000*	—	—	ns	VDD = 5.0V
31	TWDT	Watchdog Timer Time-out Period (No Prescaler)	9.0*	18*	30*	ms	VDD = 5.0V (industrial) VDD = 5.0V (extended)
32	TDRT	Device Reset Timer Period	9.0*	18*	30*	ms	VDD = 5.0V (industrial) VDD = 5.0V (extended)
34	TIOZ	I/O high-impedance from MCLR Low	100*	300*	2000*	ns	

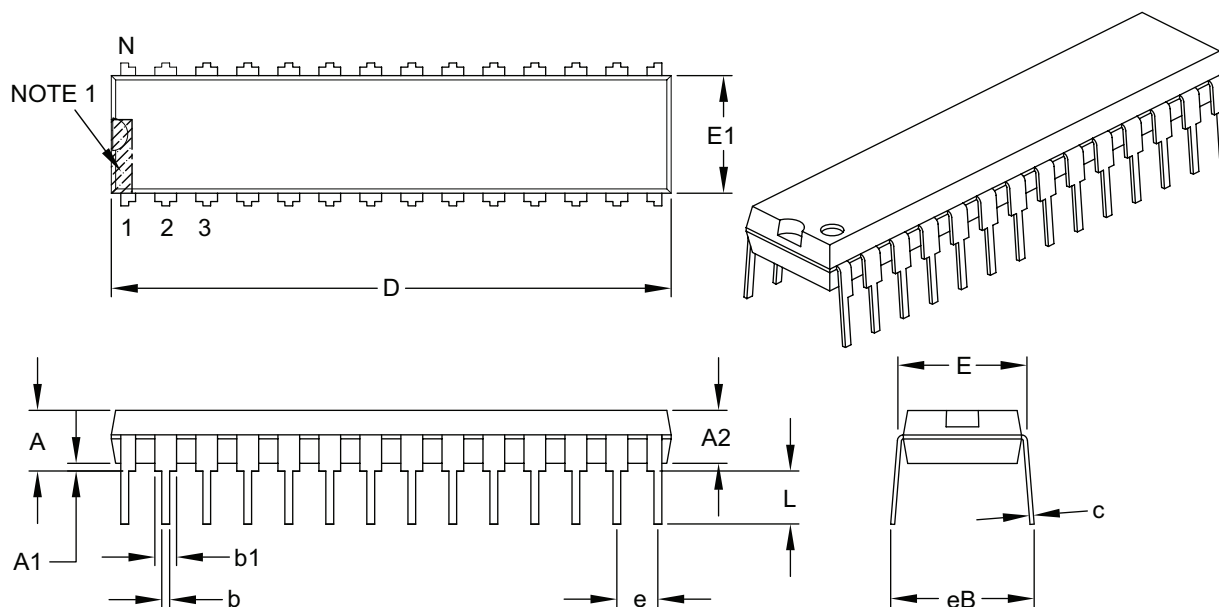
* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16F5X

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	.100 BSC		
Top to Seating Plane	A	–	–	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

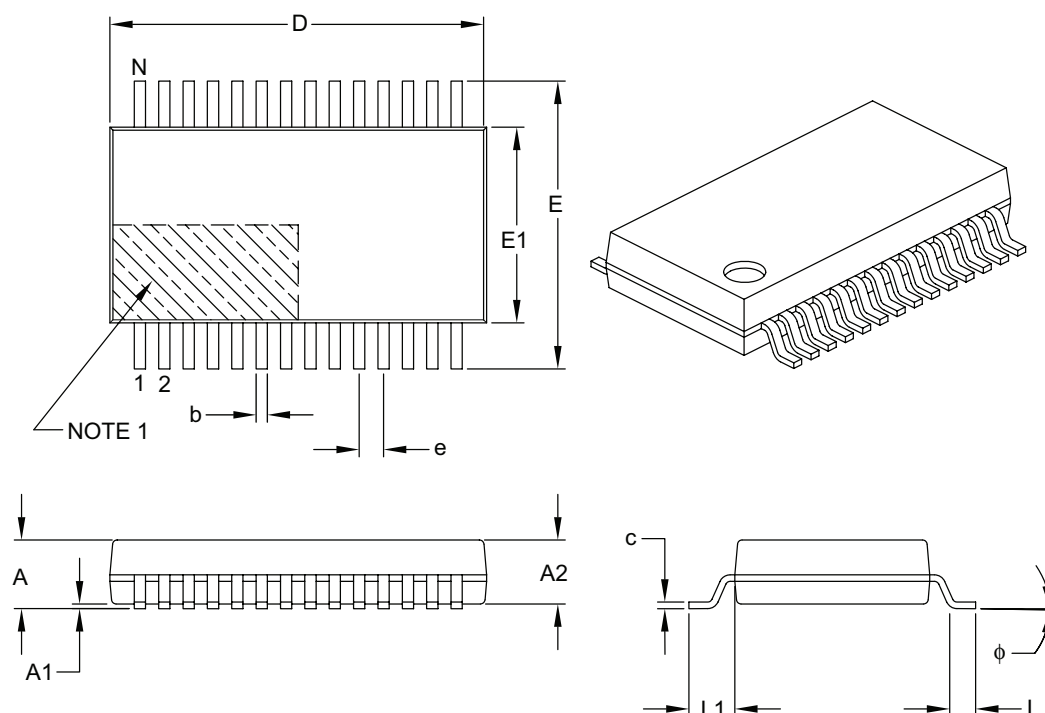
- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	0.65 BSC		
Overall Height	A	–	–	2.00
Molded Package Thickness	A2	1.65	1.75	1.85
Standoff	A1	0.05	–	–
Overall Width	E	7.40	7.80	8.20
Molded Package Width	E1	5.00	5.30	5.60
Overall Length	D	9.90	10.20	10.50
Foot Length	L	0.55	0.75	0.95
Footprint	L1	1.25 REF		
Lead Thickness	c	0.09	–	0.25
Foot Angle	φ	0°	4°	8°
Lead Width	b	0.22	–	0.38

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B



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